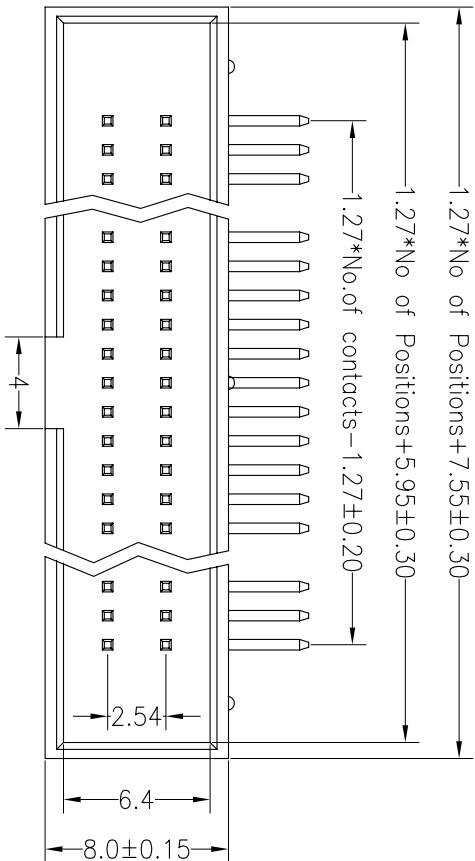


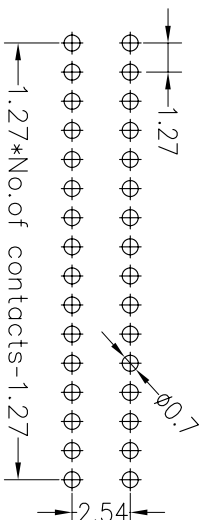
SPECIFICATIONS

Rated Current:1.0AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:500V AC/DC
 Insulation Resistance:1000MΩ Min
 Operation Temperature:-40°c to +105°c

Contact Material:Brass
 Contact Plating:Au or Sn Over Ni
 Insulator Material:Polyester(Ul94V-0)
 Standard: PA6T
 Max.Processing Temp: 230°C for 30-60 seconds
 (260°C for 10 seconds)



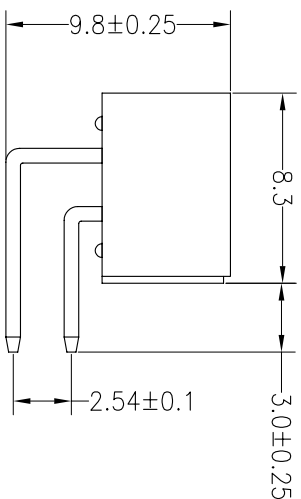
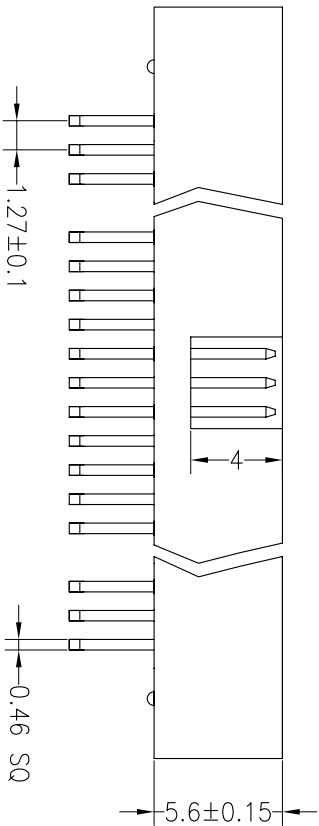
Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information

3240 XX R XX X B K00 X01

- No. of Pins 10-100P
- Contact Plating Option: G0:Gold Flash, G2:5U" Gold, G3:10U" Gold, G4:15U" Gold, G5:30U" Gold, S0:Gold Flash/Tin, SN:Tin
- Insulator Material Option: A=BK-PBT, B=BK-PA66, C=BK-PA6T, D=BK-PA46, E=BK-PA9T, F=BK-LCP
- Packing Option: 0=Pe Bag, T=Tube, A=Tray, P=Tube+Cap, R=Reel+Cap



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION		DRAW	BEN	14.04.18	SCALE		FIT	PART NO.	TITLE:
				X.X	±0.30				UNIT	mm			
A0	2014.04.18	NEW DRAWING		X.XX	±0.20	CHECK							
1				X.XX	±0.10	APPROVE							

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